

| Approval Specification | Customer's Approval Certificate | | | |
|------------------------|---|--|--|--|
| TO: | Checked & Approved by: | | | |
| Part No.: | Date: | | | |
| Customer's Part No.: | Please return this copy as a certification of your approval | | | |

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| Part No. | : | SFR315K |
|----------|---|-----------|
| Pages | : | 7 |
| Date | : | 2015/1/21 |
| Revision | : | 1.0 |







| Prepared by: | 星档林 |
|--------------|-----|
| Checked by: | 张伟 |
| Approved by: | 商燕港 |

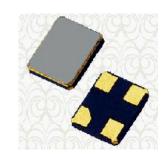
History Record

| Date | Part No. | Version No. | Modify Content | Remark |
|------|----------|-------------|----------------|--------|
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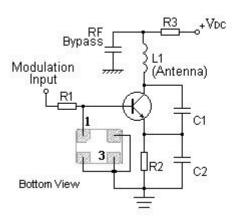
Features

- 1-port Resonator
- Ceramic Package for Surface Mounted Technology (SMT)
- **RoHS** compatible
- Package size 3.20x2.50x0.70mm³
- Electrostatic Sensitive Device(ESD)

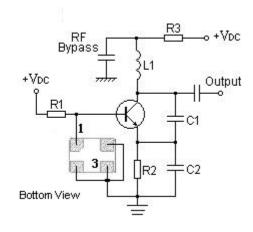


Application

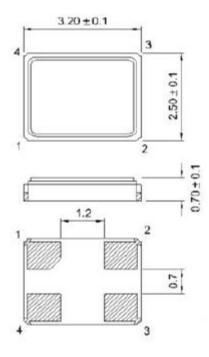
Typical Low-Power Transmitter Application



Typical Local Oscillator Application



Package Dimensions (DCC4C)



Pin Configuration

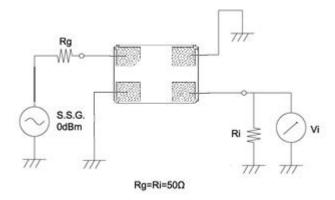
| 1 | Input/ Output | |
|-----|---------------|--|
| 3 | Output/ Input | |
| 2,4 | Ground | |

Marki

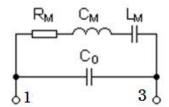


| SF | Trademark | |
|------|---------------|--|
| R | SAW Resonator | |
| 315K | Part number | |

Test Circuit



Equivalent LC Model



Performance

Maximum Rating

| ltem | | Value | Unit |
|-----------------------|------------------|-----------|------|
| DC Voltage | V _{DC} | ±30 | V |
| Operation Temperature | Т | -40 ~ +85 | °C |
| Storage Temperature | T _{stg} | -40 ~ +85 | °C |
| RF Power Dissipation | Р | 15 | dBm |

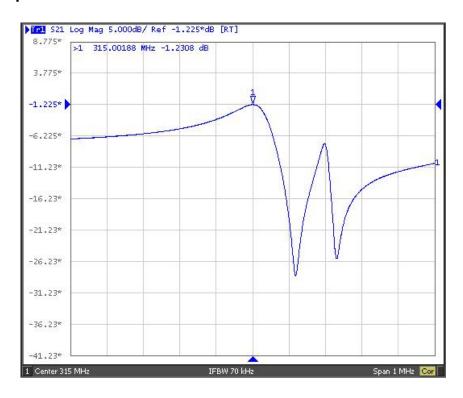
Electronic Characteristics

Test Temperature: 25°C±2°C

Terminating source impedance: 50Ω Terminating load impedance: 50Ω

| | ltem | | Minimum | Typical | Maximum | Unit |
|---|--|-----------------|---------|---------|---------|--------|
| Center | Absolute Frequency | fc | | 315.00 | | MHz |
| Frequency | Tolerance from 315.00MHz | $\triangle f_c$ | | ±75 | | KHz |
| Insertion Loss(r | nin) | IL | | 1.3 | 2.0 | dB |
| Quality Factor | Unloaded Q | Qυ | | 21571 | | |
| Quality Factor | 50Ω Loaded Q | Q_L | | 3559 | | |
| Frequency Aging | ' Ansolute value during the First Year | | | ≤10 | | ppm/yr |
| DC Insulation Resistance between Any Two Pins | | | 1.0 | | | ΜΩ |
| RF Equivalent RLC Model | Motional Resistance | R _M | | 19.7 | 22.0 | Ω |
| | Motional Inductance | L _M | | 215.5 | | μН |
| | Motional Capacitance | См | | 1.18 | | fF |
| | Static Capacitance | C ₀ | 1.80 | 2.08 | 2.4 | pF |

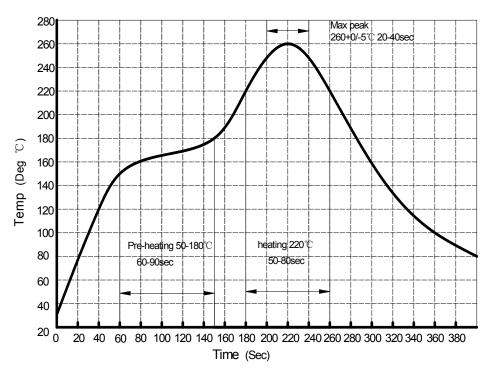
Frequency Response



Reliability (The SAW components shall remain electrical performance after tests)

| No. | Test item | Test condition | | |
|-----|---------------------------------|--|--|--|
| 1 | Temperature Storage | (1) Temperature: 85°C±2°C , Duration: 250h , Recovery time: 2h±0.5h (2) Temperature: -40°C±3°C , Duration: 250h ,Recovery time: 2h±0.5h | | |
| 2 | Humidity Test | Conditions: 60°C±2°C , 90~95% RH Duration: 250h | | |
| 3 | Thermal Shock | Heat cycle conditions: TA=-40°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min , Cycle time: 100 times , Recovery time : 2h±0.5h. | | |
| 4 | Vibration Fatigue | Frequency of vibration: 10~55Hz Amplitude:1.5mm Directions: X,Y and Z Duration: 2h | | |
| 5 | Drop Test | Cycle time: 10 times Height: 1.0m | | |
| 6 | Solder Ability Test | Temperature: 245°C±5°C Duration: 3.0s5.0s Depth: DIP2/3 , SMD1/5 | | |
| 7 | Resistance to Soldering Heat | (1)Thickness of PCB:1mm , Solder condition: 260°C±5°C , Duration: 10±1s (2)Temperature of Soldering Iron: 350°C±10°C , Duration: 3~4s , Recovery time : 2 ± 0.5h | | |

Recommended Reflow Soldering Diagram



SAW Resonator SFR315K 315.00MHz

Notes

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may **be soldered**. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.

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